



SN74AUP1T34-Q1 1 位单向电压电平转换器

1 特性

- 适用于汽车电子 应用
 - 符合 AEC-Q100 标准
 - 器件温度等级 1: -40°C 至 125°C 的环境运行温度范围
 - 器件人体放电模式 (HBM) 静电放电 (ESD) 分类等级 3A
 - 带电器件模型 (CDM) ESD 分类等级 C5
- 0.9V 至 3.6V 的宽运行 VCC 范围
- 均衡的传播延迟: $t_{PLH} = t_{PHL}$ (1.8V 至 3.3V 转换时的典型值)
- 低静态功耗: ICC 最高为 5μA
- ±6mA 输出驱动 (电压为 3V 时)
- I_{off} 支持部分掉电模式运行
- VCC 隔离特性 – 如果 V_{CCA} 输入接地, 则 B 端口处于高阻态
- 输入滞后可实现输入转换和输入上更好的开关噪声抗扰度
- 静电放电 (ESD) 保护性能超过 JESD 22 规范要求
- 5000V 人体模型 (AEC-Q100-002-E)
- 锁存性能满足 100mA, 符合 Q100-004-D 规范

2 应用范围

- 汽车
- 企业
- 工业
- 个人电子产品
- 电信

3 说明

SN74AUP1T34-Q1 器件是一款 1 位非反向转换器, 使用两条独立的可配置电源轨。该单向转换器在 A 和 B 两端口间转换。A 端口设计用于跟踪 V_{CCA}。V_{CCA} 可接受从 0.9V 到 3.6V 范围内的电源电压。B 端口设计用于跟踪 V_{CCB}。V_{CCB} 可接受从 0.9V 至 3.6V 间的电源电压值。这可实现 1V, 1.2V, 1.5V, 1.8V, 2.5V 和 3.3V 电压节点间的低压转换。此外, SN74AUP1T34-Q1 完全适用于使用 I_{off} 的局部掉电应用。 I_{off} 电路会禁用输出, 从而在器件掉电时防止电流回流损坏器件。

VCC 隔离特性确保了在 V_{CCA} 输入在 GND 上时, B 端口处于高阻抗状态。如果 V_{CCB} 输入在 GND 上, 到 A 侧的任一输入都不会导致泄漏电流, 即使在悬空状态时也是如此。

器件信息⁽¹⁾

器件型号	封装	封装尺寸 (标称值)
SN74AUP1T34-Q1	SC70 (5)	2.00mm × 1.25mm

(1) 要了解所有可用封装, 请参见数据表末尾的可订购产品附录。

示例应用图



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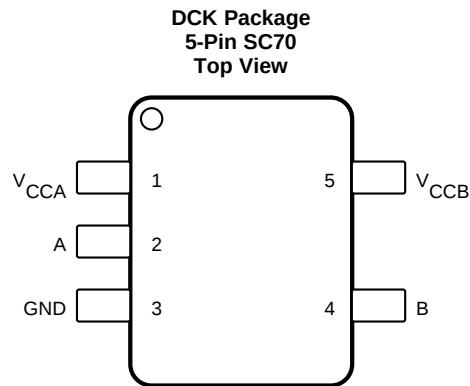
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4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

Changes from Original (December 2013) to Revision A	Page
• 已添加 ESD 额定值表，特性 描述部分，器件功能模式，应用和实施部分，电源相关建议部分，布局部分，器件和文档支持部分以及机械、封装和可订购信息部分。	1
• 已删除 订购信息表	1

5 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
A	2	I	Input Port. Referenced to V_{CCA} .
B	4	O	Output Port. Referenced to V_{CCB} .
GND	3	—	Ground.
V_{CCA}	1	—	Input Port DC Power Supply.
V_{CCB}	5	—	Output Port DC Power Supply.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CCA} , V_{CCB}	Supply voltage		−0.3	4	V
V_I	Input voltage		−0.5	4.6	V
V_O	Voltage applied to any output in the high-impedance or power-off state		−0.5	4.6	V
	Voltage applied to any output in the high or low state		−0.5	4.6	
I_{IK}	Input clamp current	$V_I < 0$		−50	mA
I_{OK}	Output clamp current	$V_O < 0$		−50	mA
I_O	Continuous output current			±50	mA
	Continuous current through V_{CCA} or GND			±100	mA
T_{stg}	Storage temperature		−65	150	°C

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ , Classification 3A	5000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ , Classification C5	750	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

SN74AUP1T34-Q1

ZHCSEZ0A – DECEMBER 2013 – REVISED APRIL 2016

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6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	VCCA	VCCB	MIN	MAX	UNIT
V_{CCA}, V_{CCB} Supply voltage				0.9	3.6	V
V_{IH} High-level input voltage		0.9 V to 1.95 V	0.9 V to 1.95 V	$0.65 \times V_{CCA}$		V
		2.3 V to 2.7 V	0.9 V to 3.6 V	1.6		
		3 V to 3.6 V	0.9 V to 3.6 V	2		
V_{IL} Low-level input voltage		0.9 V	0.9 V to 1.95 V	$0.3 \times V_{CCA}$		V
		1 V to 1.95 V	0.9 V to 1.95 V	$0.35 \times V_{CCA}$		
		2.3 V to 2.7 V	0.9 V to 3.6 V	0.7		
		3 V to 3.6 V	0.9 V to 3.6 V	0.9		
$\Delta t/\Delta v$ Input transition rise or fall rate		3 V to 3.6 V	0.9 V to 3.6 V		200	ns/V
T_A Operating free-air temperature				–40	125	°C
V_{OH}	$I_{OH} = -100 \mu A$	$V_I = V_{IH}$	0.9 V to 3.6 V	0.9 V to 3.6 V	$V_{CCB} - 0.2$	V
	$I_{OH} = -0.25 \text{ mA}$		0.9 V to 1 V	0.9 V to 1 V	$0.75 \times V_{CCB}$	
	$I_{OH} = -1.5 \text{ mA}$		1.2 V	1.2 V	1	
	$I_{OH} = -2 \text{ mA}$		1.65 V	1.65 V	1.32	
	$I_{OH} = -3 \text{ mA}$		2.3 V	2.3 V	1.9	
	$I_{OH} = -6 \text{ mA}$		3 V	3 V	2.72	
V_{OL}	$I_{OL} = 100 \mu A$	$V_I = V_{IL}$	0.9 V to 3.6 V	0.9 V to 3.6 V	0.1	V
	$I_{OL} = 0.25 \text{ mA}$		0.9 V to 1 V	0.9 V to 1 V	0.1	
	$I_{OL} = 1.5 \text{ mA}$		1.2 V	1.2 V	$0.3 \times V_{CCB}$	
	$I_{OL} = 2 \text{ mA}$		1.65 V	1.65 V	0.31	
	$I_{OL} = 3 \text{ mA}$		2.3 V	2.3 V	0.31	
	$I_{OL} = 6 \text{ mA}$		3 V	3 V	0.31	
I_i Control inputs	$V_i = V_{CCA}$ or GND	0.9 V to 3.6 V	0.9 V to 3.6 V		± 1	μA
I_{off} A or B port	V_I or $V_O = 0$ to 3.6 V	0 V	0 V to 3.6 V		± 5	μA
		0 V to 3.6 V	0 V		± 5	
I_{CCA}	$V_I = V_{CCI}$ or GND, $I_O = 0 \text{ mA}$	0.9 V to 3.6 V	0.9 V to 3.6 V		2.7	μA
		0.9 V to 3.6 V	V_{CCA}		2	
		0 V	0 V to 3.6 V		1	
		0 V to 3.6 V	0 V		1	
I_{CCB}	$V_I = V_{CCI}$ or GND, $I_O = 0 \text{ mA}$	0.9 V to 3.6 V	0.9 V to 3.6 V		2.7	μA
		0.9 V to 3.6 V	V_{CCA}		2	
		0 V	0 V to 3.6 V		1	
		0 V to 3.6 V	0 V		1	
$I_{CCA} + I_{CCB}$	$V_I = V_{CCI}$ or GND, $I_O = 0 \text{ mA}$	0.9 V to 3.6 V	0.9 V to 3.6 V		5.4	μA
C_{io} A or B port		3.3 V	3.3 V		4	pF

6.4 Thermal Information

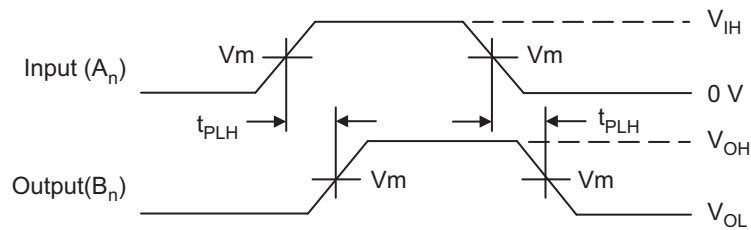
THERMAL METRIC ⁽¹⁾		SN74AUP1T34-Q1	UNIT
		DCK (SC70)	
		5 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	301.9	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	113	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	79.1	°C/W
ψ_{JT}	Junction-to-top characterization parameter	3.9	°C/W
ψ_{JB}	Junction-to-board characterization parameter	78.3	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 AC Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	C _L	VCCA	VCCB = 0.9 V		VCCB = 1.2 V		VCCB = 1.65 V		VCCB = 2.3 V		VCCB = 3 V		UNIT
			TYP	MAX	TYP	MAX	TYP	MAX	TYP	MAX	TYP	MAX	
t _{PLH} /t _{PHL}	5 pF	0.9 V	25		18		16.2		16.3		16.8		ns
	5 pF	1.2 V		42.5		24.9		23.2		22.6		22.5	
	5 pF	1.65 V		40		10.7		8.84		8.08		7.88	
	5 pF	2.3 V		41.3		8.02		5.73		4.92		4.2	
	5 pF	3 V		42.5		7.61		4.5		3.65		3.39	
t _{PLH} /t _{PHL}	10 pF	0.9 V	28.9		19.8		17.9		18		18.5		ns
	10 pF	1.2 V		43.22		12.33		9.57		8.81		8.61	
	10 pF	1.65 V		40.44		9.21		6.57		5.6		4.73	
	10 pF	2.3 V		41.56		8.3		5.54		4.42		4.07	
	10 pF	3 V		42.81		7.87		4.8		3.8		3.36	
t _{PLH} /t _{PHL}	15 pF	0.9 V	30.6		21.6		19.6		19.7		20.3		ns
	15 pF	1.2 V		43.87		16.2		11.8		11		11	
	15 pF	1.65 V		40.78		14.7		8.8		7.1		6.4	
	15 pF	2.3 V		41.79		14.9		7.6		5.88		5.27	
	15 pF	3 V		43.09		16.2		6.98		5.4		4.7	
t _{PLH} /t _{PHL}	30 pF	0.9 V	32.1		21.3		18.7		18		18.3		ns
	30 pF	1.2 V		45.65		15.1		12.37		11.61		11.41	
	30 pF	1.65 V		41.72		12.18		8.15		6.94		6.1	
	30 pF	2.3 V		42.44		12.35		7.25		5.55		4.97	
	30 pF	3 V		43.69		11.6		6.92		4.95		4.35	



$$V_{MI} = V_{IH}/2; V_{MO} = V_{CCB}/2$$

$$t_R = t_F = 2.0 \text{ ns, 10\% to 90\%}; f = 1 \text{ MHz}; t_W = 500 \text{ ns}$$

Figure 1. Waveform 1 - Propagation Delays

6.6 Typical Characteristics

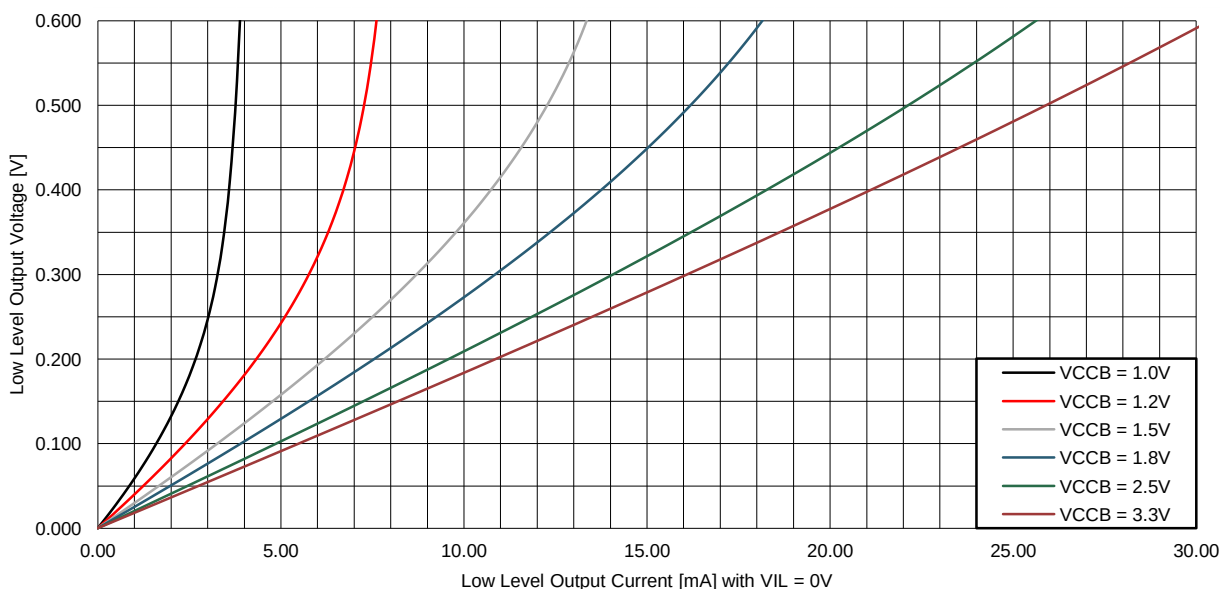
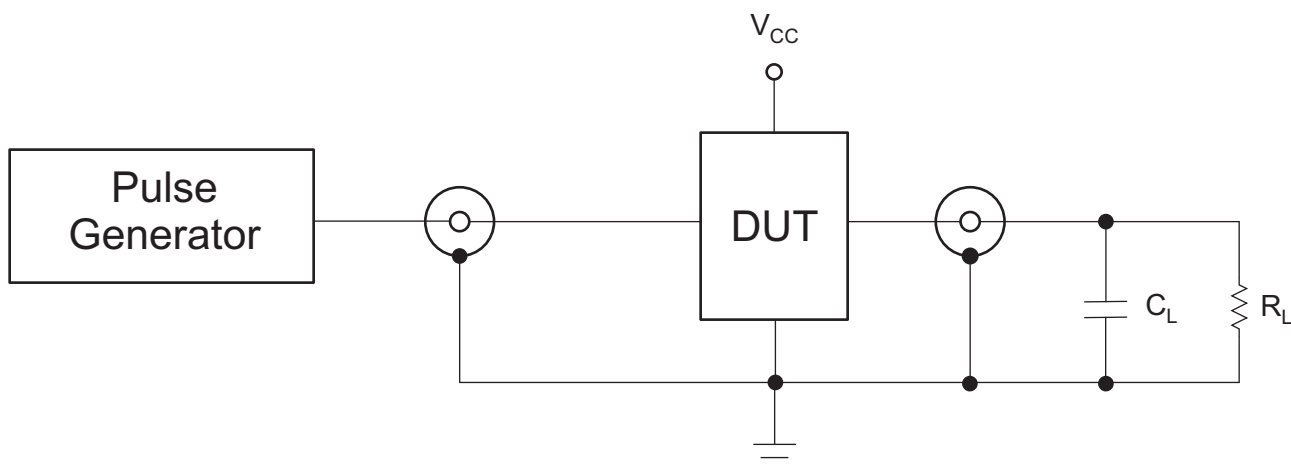


Figure 2. Low Level Output Voltage vs Low Level Output Current

7 Parameter Measurement Information



TEST

t_{PLH} , t_{PHL}

C_L = 5 pF, 10 pF, 15 pF, 30 pF or equivalent (includes probe and jig capacitance)

R_L = 1 M Ω or equivalent

Z_{OUT} of pulse generator = 50 Ω

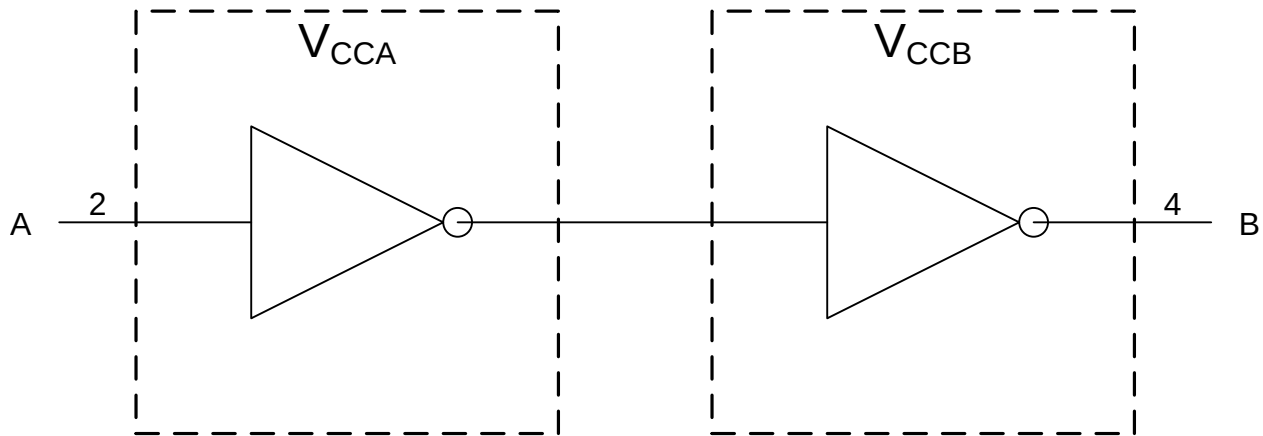
Figure 3. AC (Propagation Delay) Test Circuit

8 Detailed Description

8.1 Overview

The SN74AUP1T34-Q1 is a unidirectional, single-bit, dual-supply, noninverting voltage-level translator. Pin A, which is referenced to V_{CCA} , receives the signal that is to be level translated. Pin B, which is referenced to V_{CCB} , transmits the level translated signal. Both supply pins V_{CCA} and V_{CCB} support a voltage range from 0.9 V to 3.6 V.

8.2 Functional Block Diagram



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8.3 Feature Description

8.3.1 Fully Configurable Dual-Rail Design

Both V_{CCA} and V_{CCB} can be supplied at any voltage from 0.9 V to 3.6 V, making the device suitable for translating between any of the voltage nodes (1 V, 1.2 V, 1.8 V, 2.5 V, and 3.3 V).

8.3.2 Partial-Power-Down Mode Operation

I_{off} circuitry disables the outputs, preventing damaging current backflow through the SN74AUP1T34-Q1 when it is powered down. This can occur in applications where subsections of a system are powered down (partial-power-down) to reduce power consumption.

8.3.3 V_{CC} Isolation

The V_{CC} isolation feature ensures that if either V_{CCA} or V_{CCB} are at GND (or < 0.4 V), both ports A and B are set to a high-impedance state, preventing false logic levels from being presented to either bus.

8.3.4 Input Hysteresis

Input hysteresis allows the input to support slew rates as slow as 200 ns/V, improving switching noise immunity.

8.4 Device Functional Modes

Table 1 lists the functional modes of the SN74AUP1T34-Q1.

Table 1. Function Table

INPUT	OUTPUT
A PORT	B PORT
L	L
H	H

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The SN74AUP1T34-Q1 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another.

9.2 Typical Application

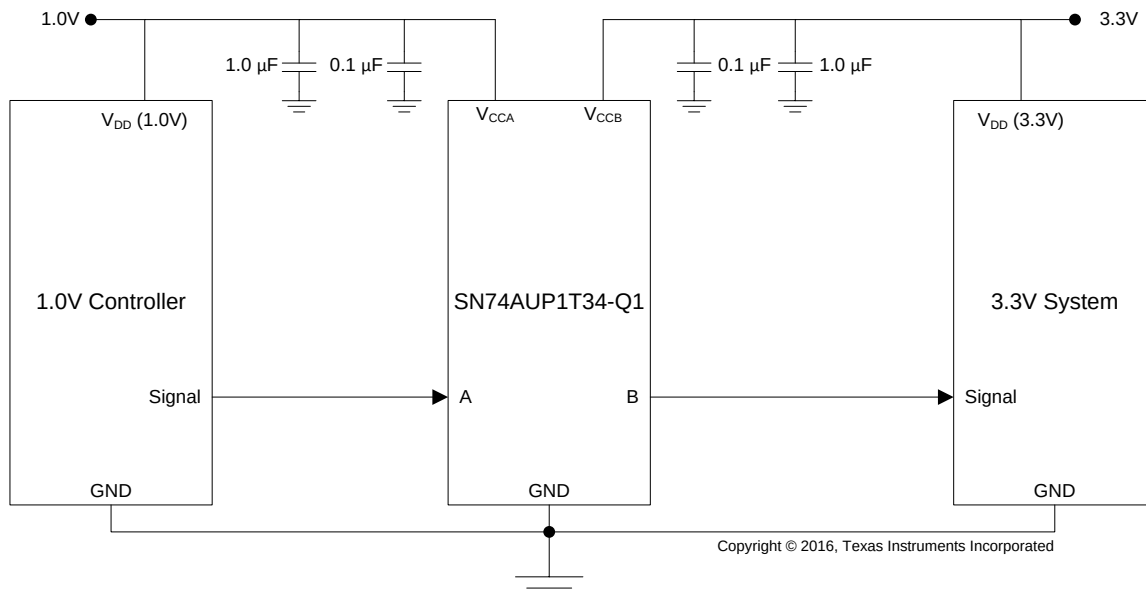


Figure 4. Typical Application Example

9.2.1 Design Requirements

Table 2 lists the design requirements of the SN74AUP1T34-Q1.

Table 2. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Input Voltage Range	0.9 V to 3.6 V
Output Voltage Range	0.9 V to 3.6 V

9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
 - Use the supply voltage of the device that is driving the SN74AUP1T34-Q1 device to determine the input voltage range. For a valid logic-high, the value must exceed the V_{IH} of the input port. For a valid logic low the value must be less than the V_{IL} of the input port.
- Output voltage range
 - Use the supply voltage of the device that the SN74AUP1T34-Q1 device is driving to determine the output voltage range.

9.2.3 Application Curve

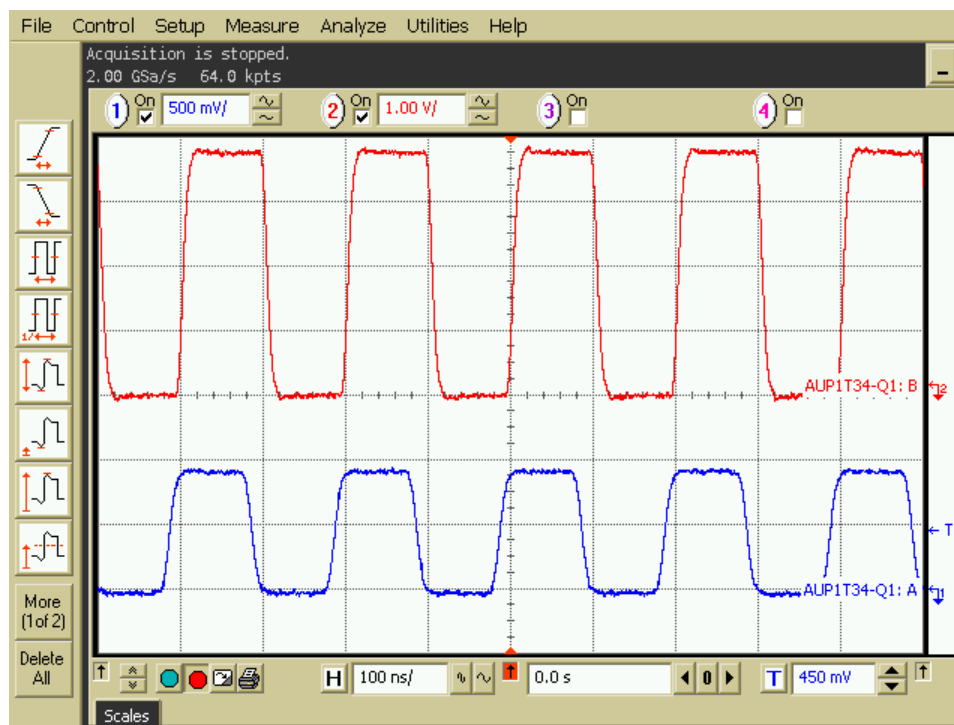


Figure 5. 10 MHz Up Translation (0.9 V to 3.6 V)

10 Power Supply Recommendations

Connect ground before applying either V_{CCA} or V_{CCB} . There is no specific power sequence requirement for the SN74AUP1T34. V_{CCA} or V_{CCB} may be powered up first, and V_{CCA} or V_{CCB} may be powered down first.

11 Layout

11.1 Layout Guidelines

To ensure reliability of the device, TI recommends following common printed-circuit board layout guidelines.

- Bypass capacitors must be used on power supplies.
- Short trace lengths must be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors helps adjust rise and fall times of signals depending on the system requirements.

11.2 Layout Example

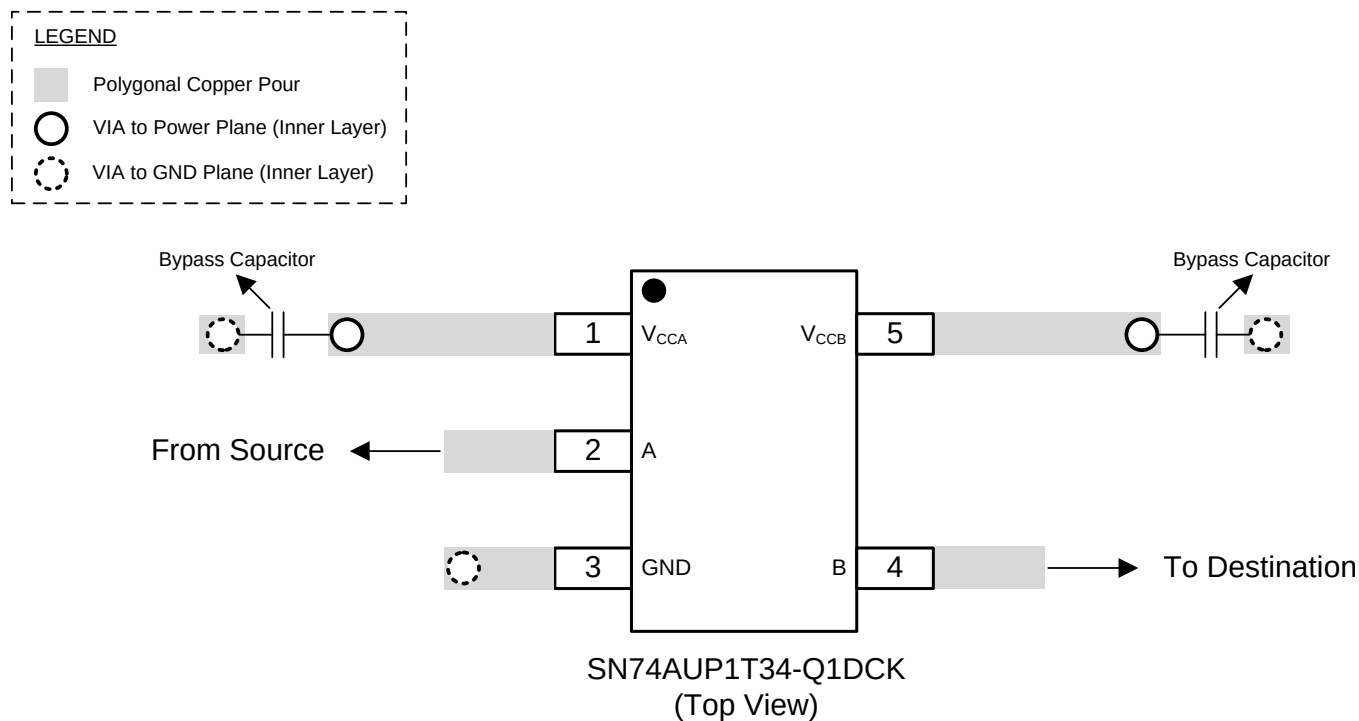


Figure 6. Example Layout

12 器件和文档支持

12.1 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.2 商标

E2E is a trademark of Texas Instruments.

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12.3 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AUP1T34QDCKRQ1	ACTIVE	SC70	CK	5	3000	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	(U4E, U4J)	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

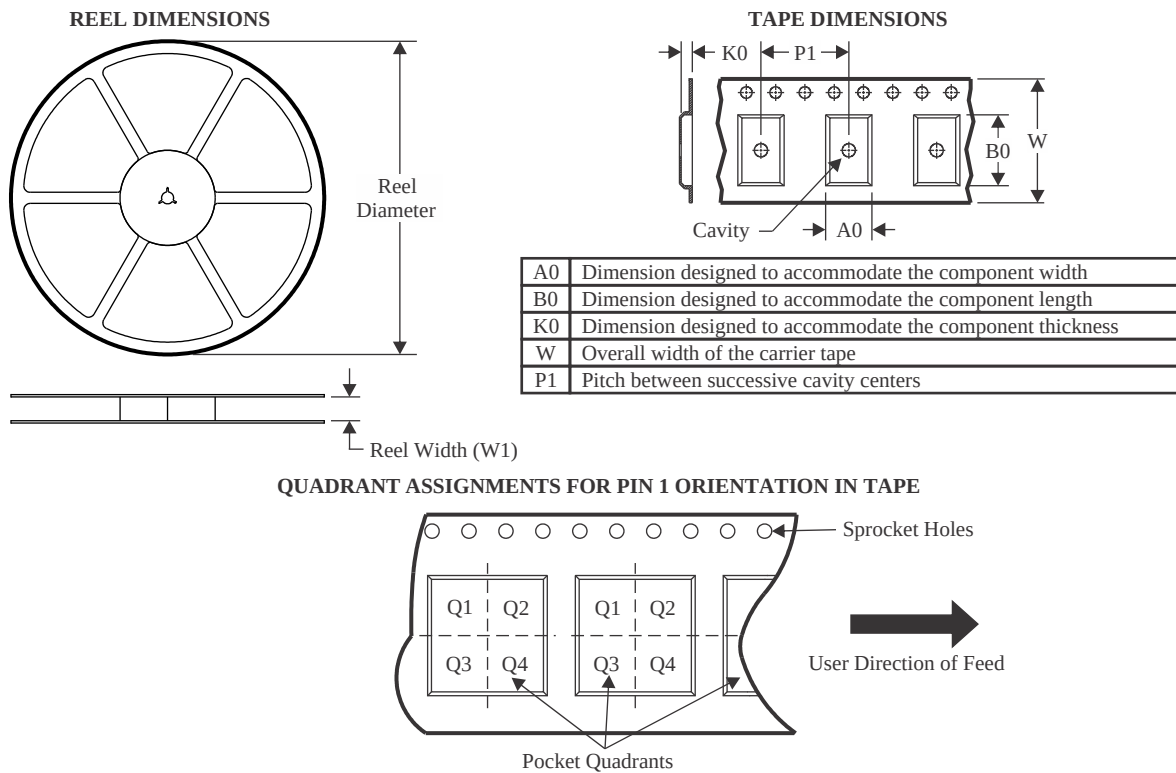
OTHER QUALIFIED VERSIONS OF SN74AUP1T34-Q1 :

- Catalog : [SN74AUP1T34](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

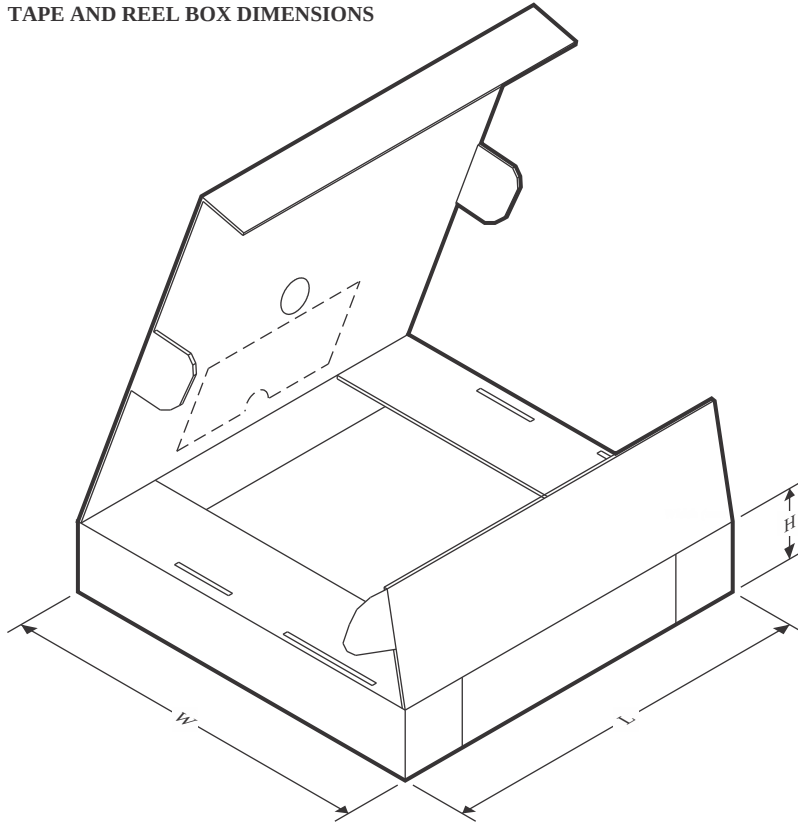
TAPE AND REEL INFORMATION



*All dimensions are nominal

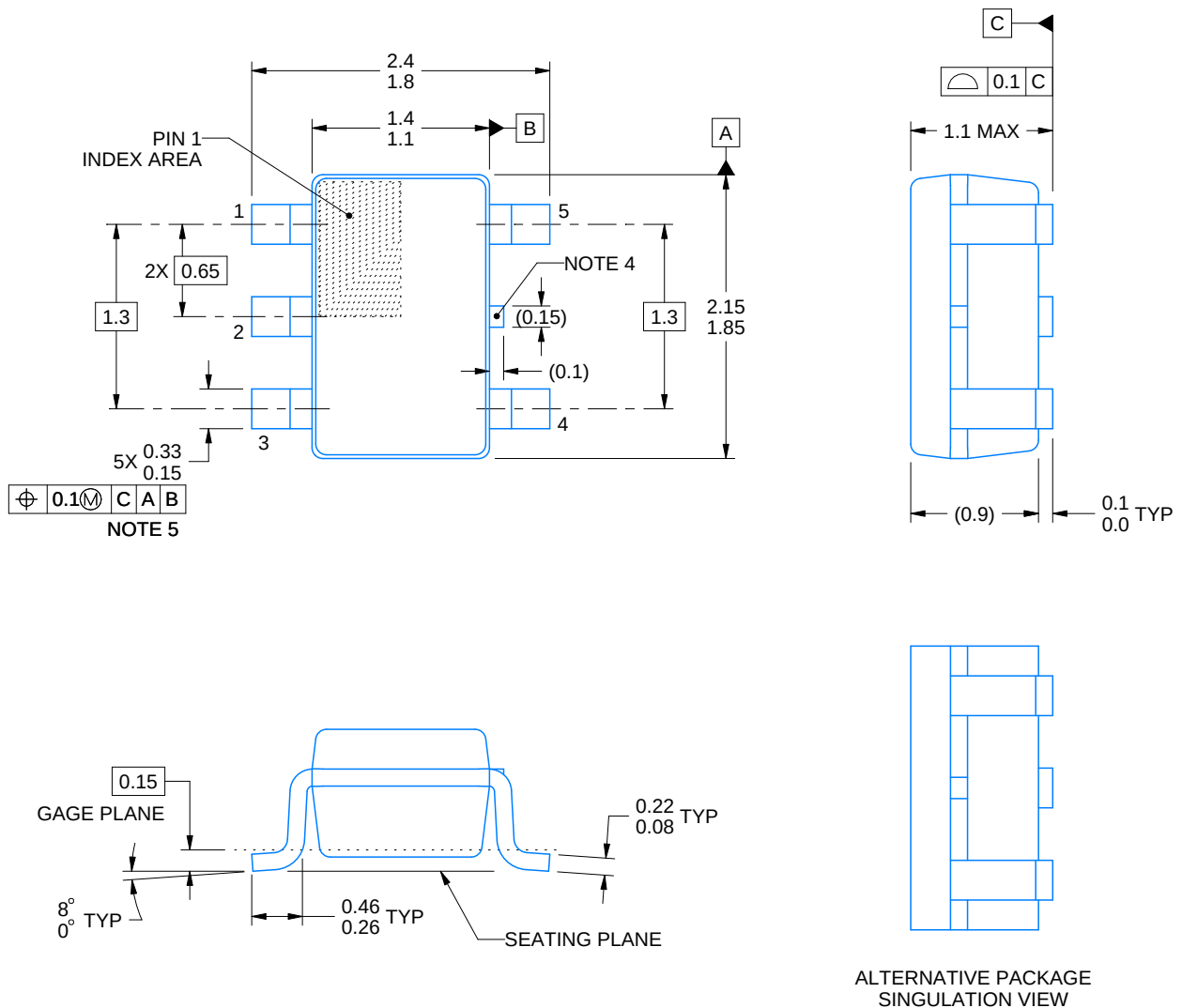
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AUP1T34QDCKRQ1	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AUP1T34QDCKRQ1	SC70	DCK	5	3000	190.0	190.0	30.0



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NOTES:

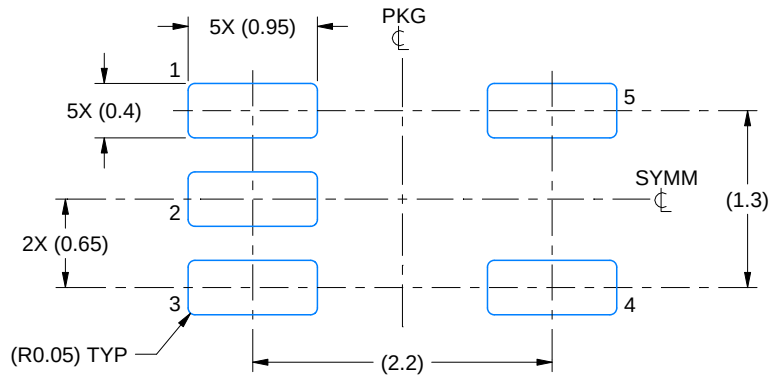
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

EXAMPLE BOARD LAYOUT

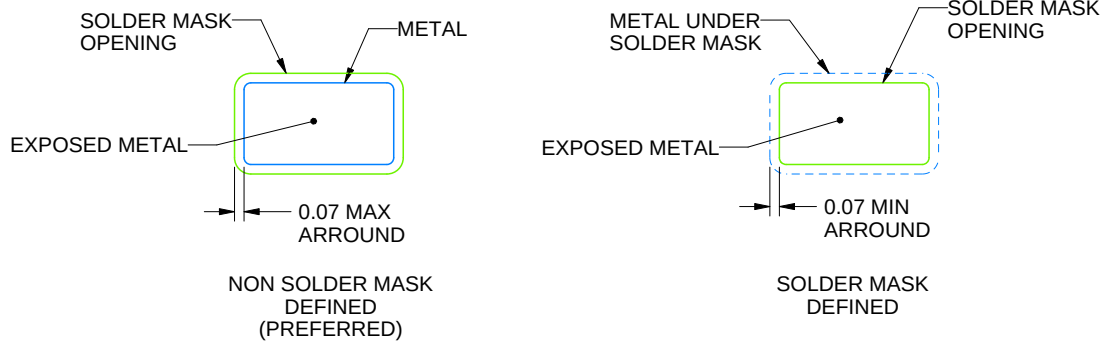
DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X

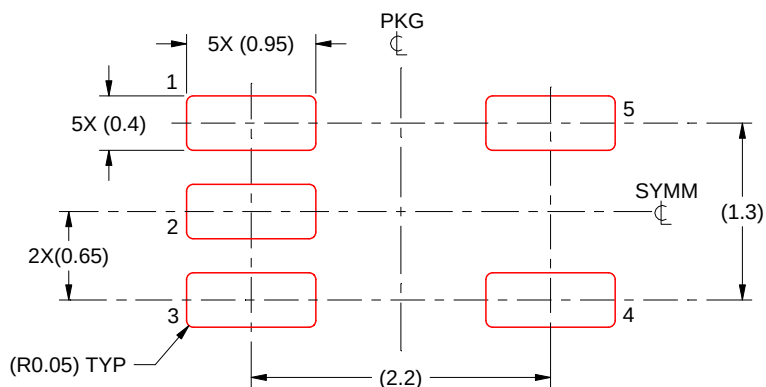


SOLDER MASK DETAILS

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NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

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NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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